

UNISONIC TECHNOLOGIES CO., LTD

7NM60 Power MOSFET

7.4A, 600V N-CHANNEL SUPER-JUNCTION MOSFET

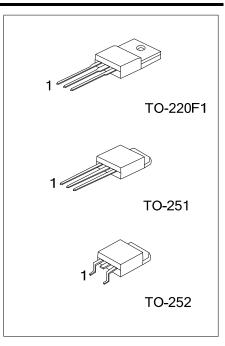
DESCRIPTION

The UTC **7NM60** is a high voltage super junction MOSFET and is designed to have better characteristics.

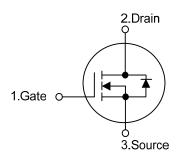
The UTC **7NM60** Utilizing an advanced charge-balance technology, enhance system efficiency, improve EMI and reliability. such as low gate charge, low on-state resistance and have a high power density and high rugged avalanche characteristics. This super junction MOSFET usually used at AC/DC power conversion, and industrial power applications.

■ FEATURES

- * $R_{DS(ON)}$ < 0.95 Ω @ V_{GS} = 10V, I_{D} = 3.7A
- * Fast Switching Capability
- * Avalanche Energy Tested
- * Improved dv/dt Capability, High Ruggedness



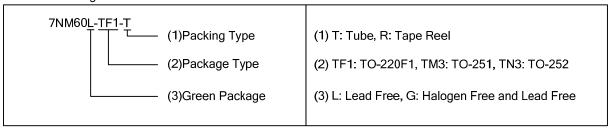
■ SYMBOL



ORDERING INFORMATION

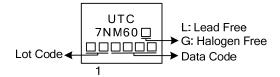
Ordering Number		Dookogo	Pin Assignment			Dooking	
Lead Free	Halogen Free	- Package	1	2	3	Packing	
7NM60L-TF1-T	7NM60G-TF1-T	TO-220F1	G	D	S	Tube	
7NM60L-TM3-T	7NM60G-TM3-T	TO-251	G	D	S	Tube	
7NM60L-TN3-R	7NM60G-TN3-R	TO-252	G	D	S	Tape Reel	

Note: Pin Assignment: G: Gate D: Drain S: Source



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■ MARKING



■ **ABSOLUTE MAXIMUM RATINGS** (T_C = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V _{DSS}	600	V
Gate-Source Voltage		V_{GSS}	±30	V
Drain Current	Continuous	Ι _D	7.4	Α
	Pulsed (Note 2)	I_{DM}	29.6	Α
Avalanche Current (Note 2)		I _{AR}	2	Α
Avalanche Energy	Single Pulsed (Note 3)	E _{AS}	65	mJ
	Repetitive (Note 2)	E _{AR}	0.1	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	3.7	V/ns
Power Dissipation	TO-220F1		48	W
	TO-251/TO-252	P _D	60	W
Derate above 25°C	TO-220F1		0.38	W/°C
	TO-251/TO-252		0.48	W/°C
Junction Temperature		T _J	+150	°C
Storage Temperature		T _{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating : Pulse width limited by $T_{\mbox{\scriptsize J}}.$
- 3. L=32.5mH, I_{AS} =2A, V_{DD} =50V, R_{G} =25 Ω , Starting T_{J} = 25°C
- 4. $I_{SD} \le 7.4 A$, di/dt $\le 200 A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25 ^{\circ}C$

■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	TO-220F1	0	62.5	°C/W
	TO-251/TO-252	θ _{JA}	110	°C/W
Junction to Case	TO-220F1	0	2.6	°C/W
	TO-251/TO-252	$\theta_{ extsf{JC}}$	2.08	°C/W

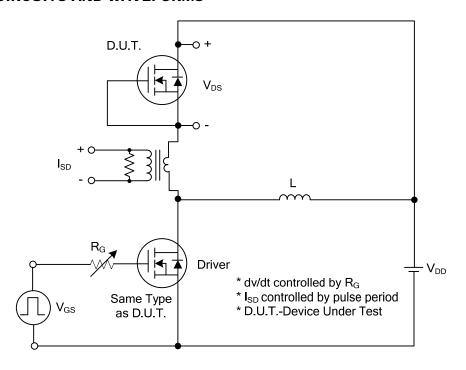
■ **ELECTRICAL CHARACTERISTICS** (T_C =25°C, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV _{DSS}	$V_{GS} = 0V, I_D = 250\mu A$	600			V
Drain-Source Leakage Current	I _{DSS}	$V_{DS} = 600V, V_{GS} = 0V$			1	μΑ
Gate- Source Leakage Current Forward		$V_{GS} = 30V, V_{DS} = 0V$			100	nA
Reverse	I _{GSS}	$V_{GS} = -30V, V_{DS} = 0V$			-100	nA
Breakdown Voltage Temperature Coefficient	$\triangle BV_{DSS}/\triangle T_{J}$	I _D =250μA,Referenced to 25°C		0.67		V/°C
ON CHARACTERISTICS						
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS} = V_{GS}$, $I_D = 250\mu A$			4.5	V
Static Drain-Source On-State Resistance	R _{DS(ON)}	$V_{GS} = 10V, I_D = 3.7A$			0.95	Ω
DYNAMIC CHARACTERISTICS				•	,	
Input Capacitance	C _{ISS}			300		pF
Output Capacitance	C _{OSS}	V_{DS} =25V, V_{GS} =0V, f=1.0MHz		120		pF
Reverse Transfer Capacitance	C _{RSS}			13		pF
SWITCHING CHARACTERISTICS						
Total Gate Charge	Q_G	 V _{DS} =50V, I _D =1.3A, I _G =100μA		19		nC
Gate-Source Charge	Q_GS	V _{GS} =10V (Note 1, 2)		5		nC
Gate-Drain Charge	Q_GD	VGS=10V (Note 1, 2)		5.5		nC
Turn-On Delay Time	t _{D(ON)}			60		ns
Turn-On Rise Time	t_R	V_{DD} =30V, I_{D} =0.5A,		100		ns
Turn-Off Delay Time	t _{D(OFF)}	$R_G = 25\Omega$ (Note 1, 2)		140		ns
Turn-Off Fall Time	t _F			70		ns
DRAIN-SOURCE DIODE CHARACTERISTI	CS AND MAXII	MUM RATINGS				
Maximum Continuous Drain-Source Diode	Is				7.4	Α
Forward Current					7.4	Α
Maximum Pulsed Drain-Source Diode	lavi				29.6	Α
Forward Current	I _{SM}				29.0	^
Drain-Source Diode Forward Voltage	V_{SD}	V _{GS} =0V, I _S =7.4A			1.4	V
Body Diode Reverse Recovery Time	t _{rr}	V _{GS} =0V, I _S =7.4A		320		nS
Body Diode Reverse Recovery Charge	Q _{rr}	dl/dt=100A/µs		3.2		nC

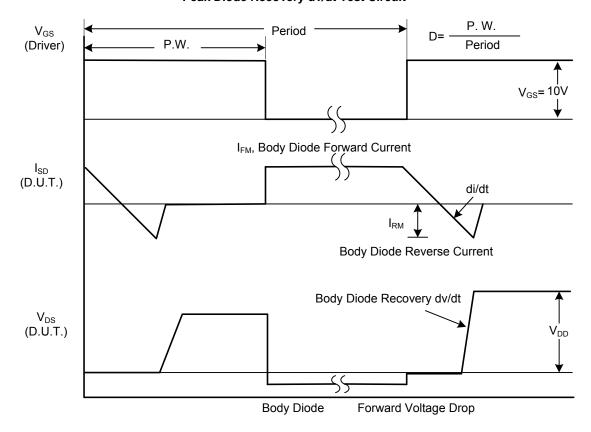
Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle≤2%.

^{2.} Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS



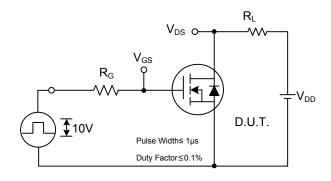
Peak Diode Recovery dv/dt Test Circuit

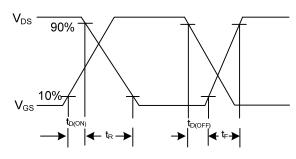


Peak Diode Recovery dv/dt Waveforms

7NM60 Power MOSFET

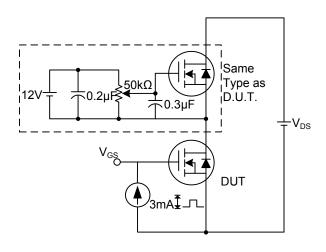
■ TEST CIRCUITS AND WAVEFORMS (Cont.)

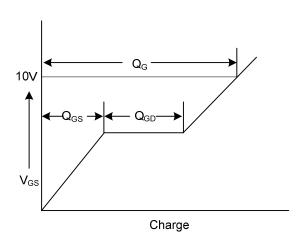




Switching Test Circuit

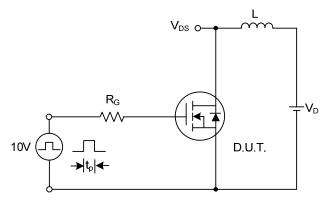
Switching Waveforms

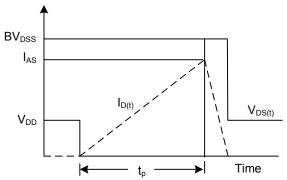




Gate Charge Test Circuit

Gate Charge Waveform





Unclamped Inductive Switching Test Circuit

Unclamped Inductive Switching Waveforms

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